

# 4V Drive Nch + Pch MOSFET

## SH8M14

### ● Structure

Silicon N-channel MOSFET/  
Silicon P-channel MOSFET

### ● Features

- 1) Low on-resistance.
- 2) High power package(SOP8).
- 3) Low voltage drive(4V drive).

### ● Application

Switching

### ● Packaging specifications

Type	Package	Taping
	Code	TB
	Basic ordering unit (pieces)	2500
SH8M14		○

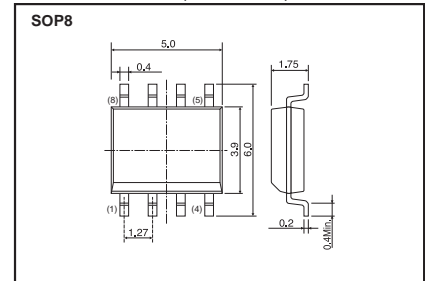
### ● Absolute maximum ratings (Ta = 25°C)

Parameter	Symbol	Limits		Unit	
		Tr1 : N-ch	Tr2 : P-ch		
Drain-source voltage	$V_{DSS}$	30	-30	V	
Gate-source voltage	$V_{GSS}$	±20	±20	V	
Drain current	Continuous	$I_D$	±9	±7	A
	Pulsed	$I_{DP}^{*1}$	±36	±28	A
Source current (Body Diode)	Continuous	$I_s$	1.6	-1.6	A
	Pulsed	$I_{sp}^{*1}$	36	-28	A
Power dissipation	$P_D^{*2}$	2.0		W / TOTAL	
		1.4		W / ELEMENT	
Channel temperature	Tch	150		°C	
Range of storage temperature	Tstg	-55 to +150		°C	

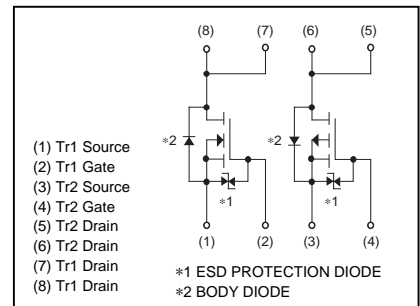
\*1  $P_w \leq 10\mu s$ , Duty cycle  $\leq 1\%$

\*2 Mounted on a ceramic board.

### ● Dimensions (Unit : mm)



### ● Inner circuit



● **Electrical characteristics** (Ta = 25°C)

<Tr1(Nch)>

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	$I_{GSS}$	-	-	±10	μA	$V_{GS}=\pm 20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	30	-	-	V	$I_D=1mA, V_{GS}=0V$
Zero gate voltage drain current	$I_{DSS}$	-	-	1	μA	$V_{DS}=30V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	1.0	-	2.5	V	$V_{DS}=10V, I_D=1mA$
Static drain-source on-state resistance	$R_{DS(on)}^*$	-	15	21	mΩ	$I_D=9A, V_{GS}=10V$
		-	18	25		$I_D=9A, V_{GS}=4.5V$
		-	20	28		$I_D=9A, V_{GS}=4V$
Forward transfer admittance	$ Y_{fs} ^*$	5.0	-	-	S	$V_{DS}=10V, I_D=9A$
Input capacitance	$C_{iss}$	-	630	-	pF	$V_{DS}=10V$
Output capacitance	$C_{oss}$	-	230	-	pF	$V_{GS}=0V$
Reverse transfer capacitance	$C_{rss}$	-	110	-	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}^*$	-	10	-	ns	$I_D=4.5A, V_{DD}=15V$
Rise time	$t_r^*$	-	33	-	ns	$V_{GS}=10V$
Turn-off delay time	$t_{d(off)}^*$	-	42	-	ns	$R_L=3.3\Omega$
Fall time	$t_f^*$	-	10	-	ns	$R_G=10\Omega$
Total gate charge	$Q_g^*$	-	8.5	-	nC	$I_D=9A, V_{DD}=15V$
Gate-source charge	$Q_{gs}^*$	-	2.3	-	nC	$V_{GS}=5V$
Gate-drain charge	$Q_{gd}^*$	-	4.0	-	nC	

\*Pulsed

● **Body diode characteristics** (Source-Drain) (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	$V_{SD}^*$	-	-	1.2	V	$I_S=9A, V_{GS}=0V$

\*Pulsed

● **Electrical characteristics** (Ta = 25°C)

<Tr2(Pch)>

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	$I_{GSS}$	-	-	±10	μA	$V_{GS}=\pm 20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	-30	-	-	V	$I_D=-1mA, V_{GS}=0V$
Zero gate voltage drain current	$I_{DSS}$		-	-1	μA	$V_{DS}=-30V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	-1.0	-	-2.5	V	$V_{DS}=-10V, I_D=-1mA$
Static drain-source on-state resistance	$R_{DS(on)}$ *	-	21.5	29.0	mΩ	$I_D=-7A, V_{GS}=-10V$
		-	29.0	39.0		$I_D=-3.5A, V_{GS}=-4.5V$
		-	31.0	40.8		$I_D=-3.5A, V_{GS}=-4.0V$
Forward transfer admittance	$ Y_{fs} $ *	6.0	-	-	S	$V_{DS}=-10V, I_D=-7A$
Input capacitance	$C_{iss}$	-	1200	-	pF	$V_{DS}=-10V$
Output capacitance	$C_{oss}$	-	170	-	pF	$V_{GS}=0V$
Reverse transfer capacitance	$C_{rss}$	-	170	-	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}$ *	-	12	-	ns	$I_D=-3.5A, V_{DD}=-15V$
Rise time	$t_r$ *	-	40	-	ns	$V_{GS}=-10V$
Turn-off delay time	$t_{d(off)}$ *	-	80	-	ns	$R_L=4.27\Omega$
Fall time	$t_f$ *	-	65	-	ns	$R_G=10\Omega$
Total gate charge	$Q_g$ *	-	18	-	nC	$I_D=-7A, V_{DD}=-15V$
Gate-source charge	$Q_{gs}$ *	-	3.5	-	nC	$V_{GS}=-5V$
Gate-drain charge	$Q_{gd}$ *	-	6.5	-	nC	

\*Pulsed

● **Body diode characteristics** (Source-Drain) (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	$V_{SD}$ *	-	-	-1.2	V	$I_S=-7A, V_{GS}=0V$

\*Pulsed

●Electrical characteristic curves (Ta=25°C)

<Tr.1(Nch)>

Fig.1 Typical Output Characteristics ( I )

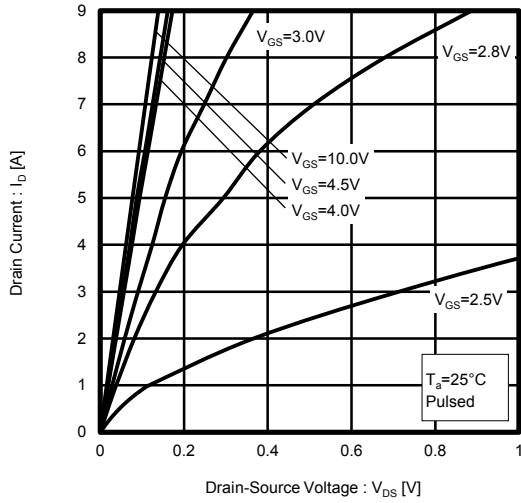


Fig.2 Typical Output Characteristics ( II )

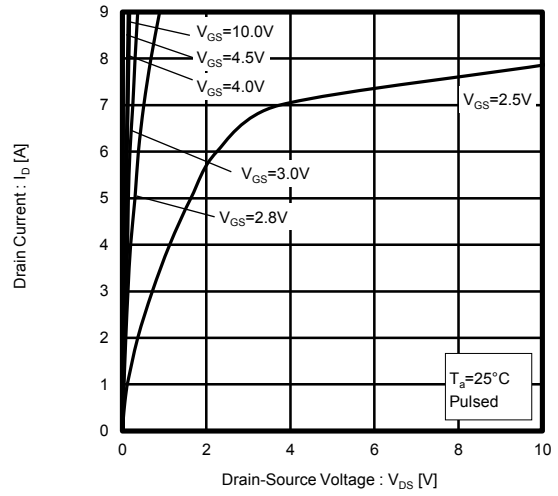


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

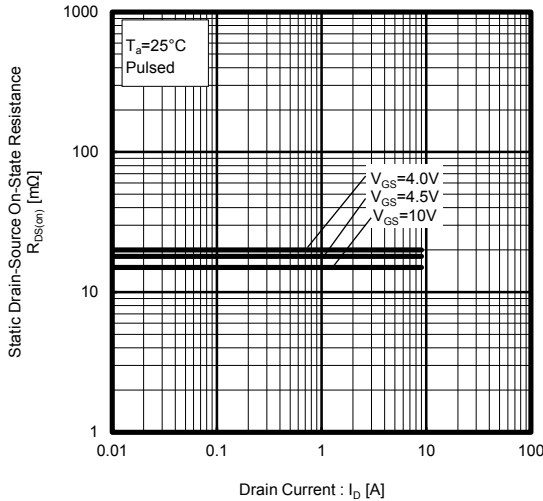


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

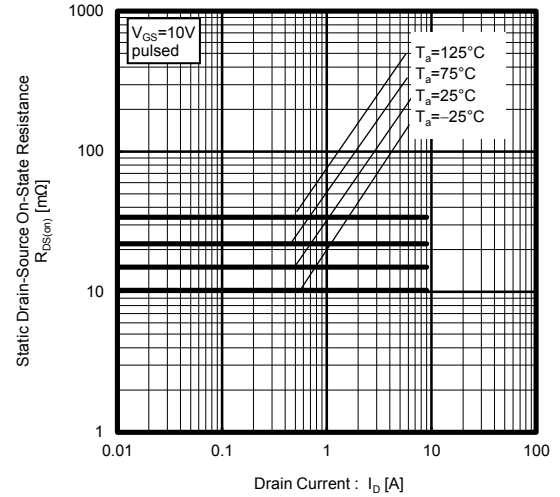


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

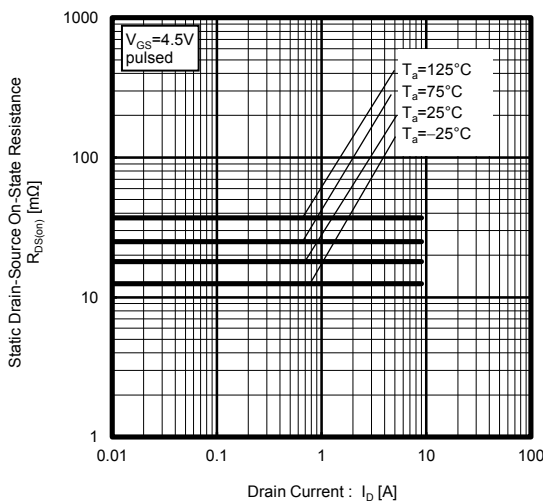


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current

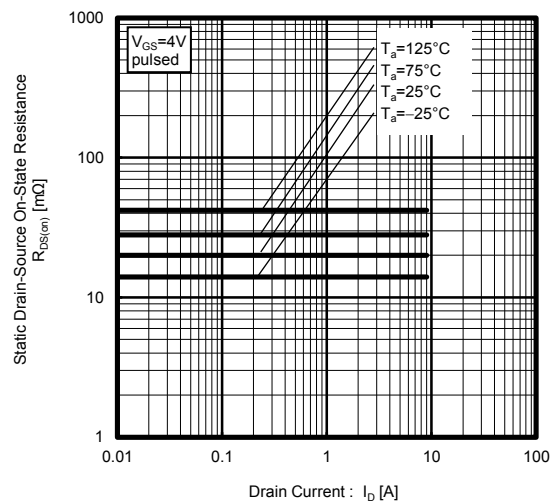


Fig.7 Forward Transfer Admittance vs. Drain Current

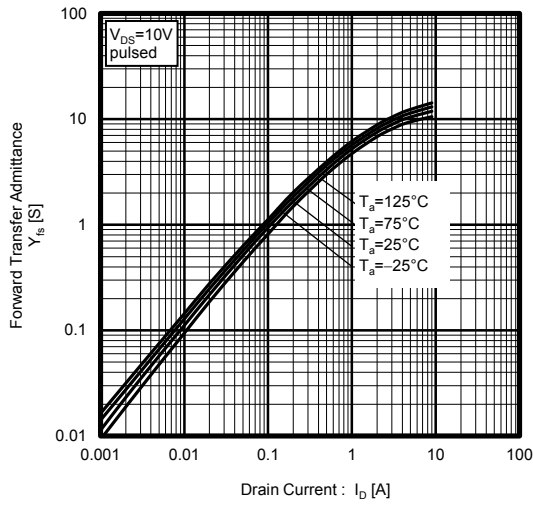


Fig.8 Typical Transfer Characteristics

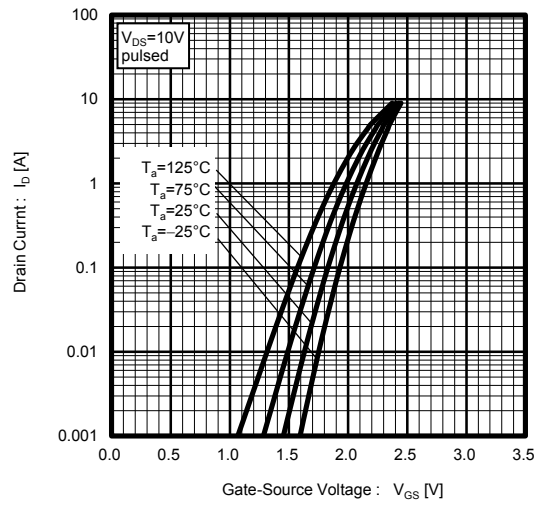


Fig.9 Source Current vs. Source-Drain Voltage

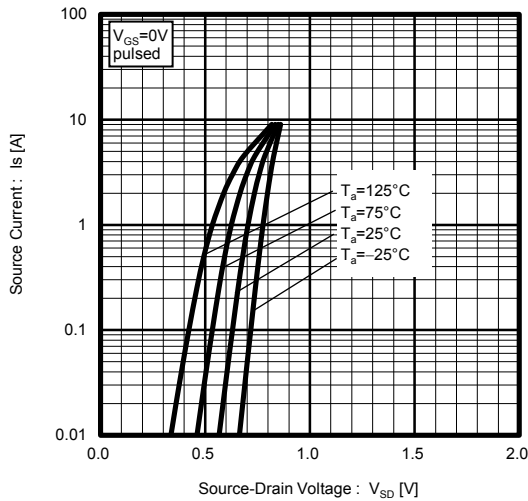


Fig.10 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

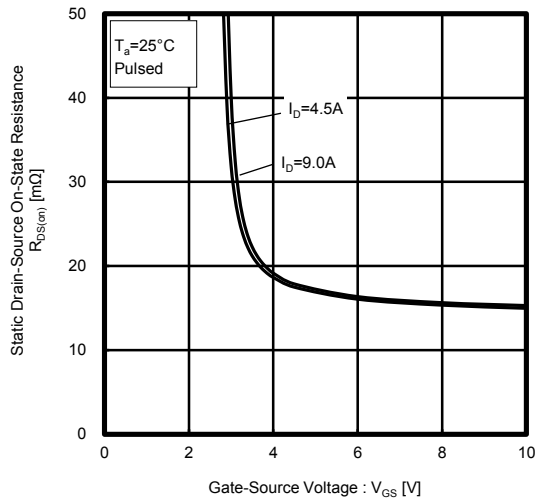


Fig.11 Switching Characteristics

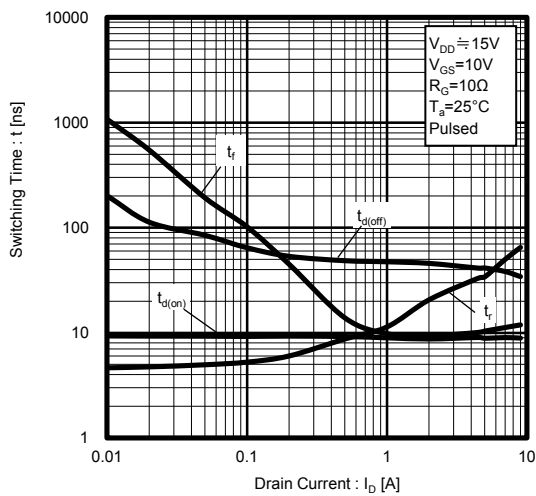


Fig.12 Dynamic Input Characteristics

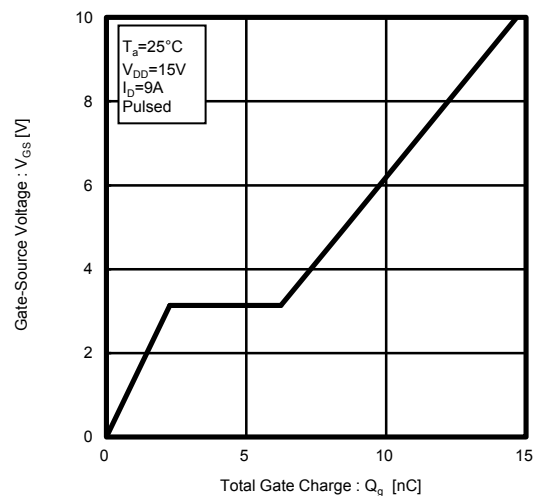


Fig.13 Typical Capacitance vs. Drain-Source Voltage

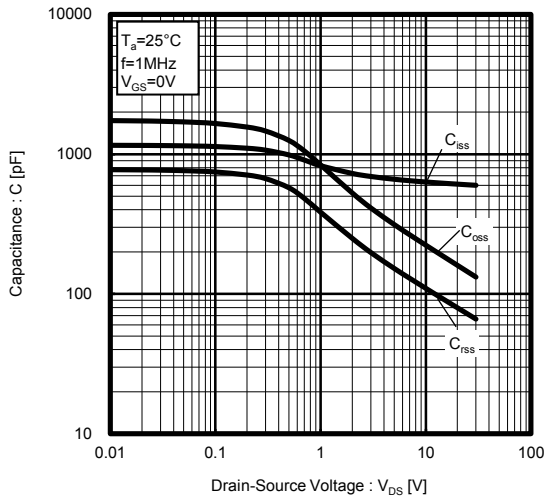


Fig.14 Maximum Safe Operating Area

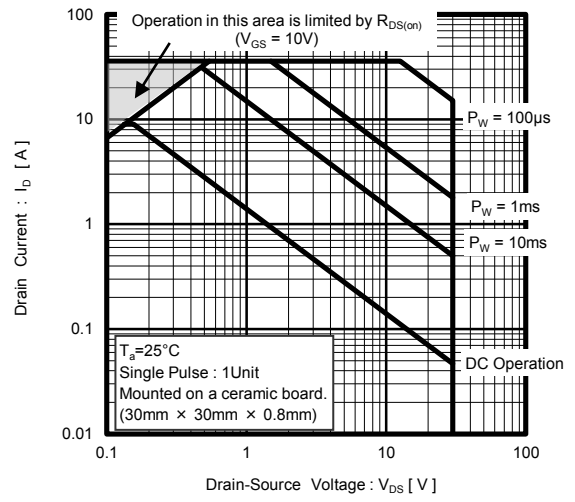
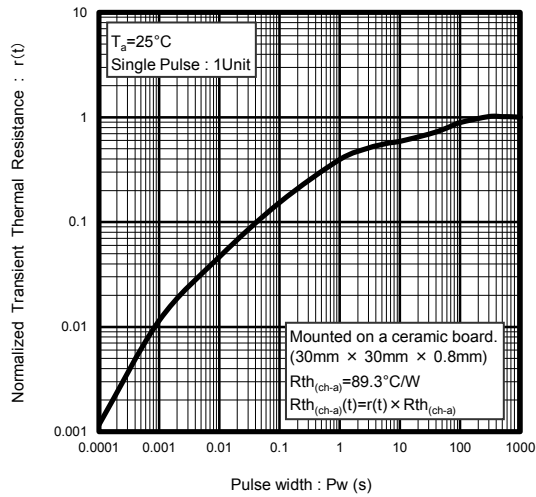


Fig.15 Normalized Transient Thermal Resistance v.s. Pulse Width



<Tr.2(Pch)>

Fig.1 Typical Output Characteristics ( I )

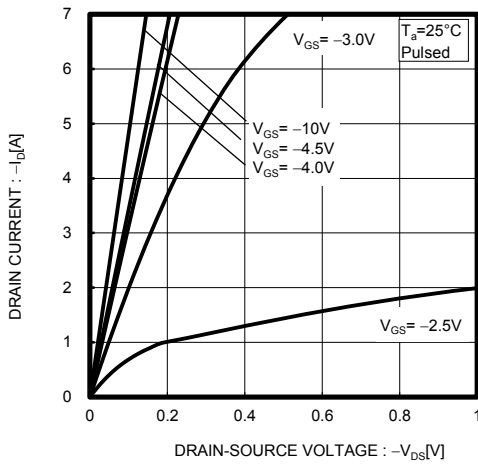


Fig.2 Typical Output Characteristics ( II )

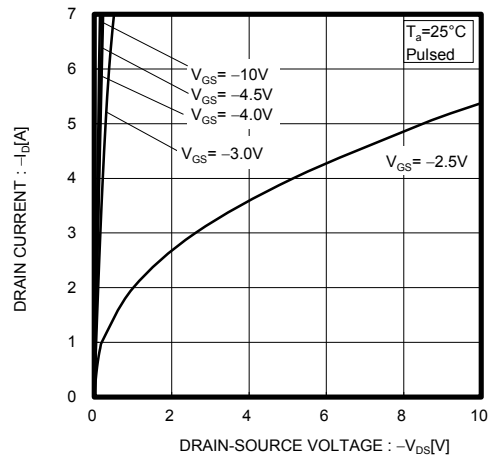


Fig.3 Typical Transfer Characteristics

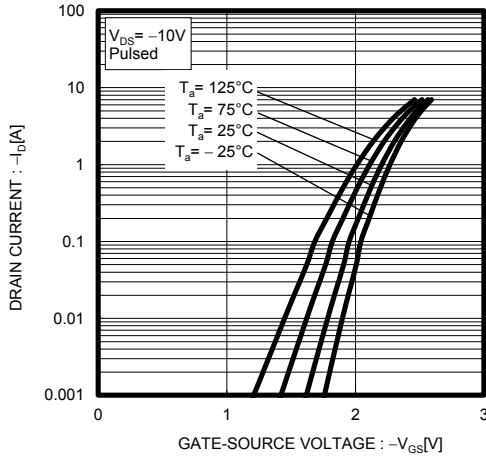


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current ( I )

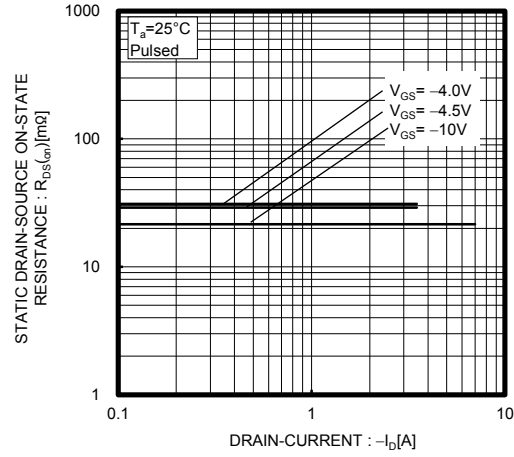


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current ( II )

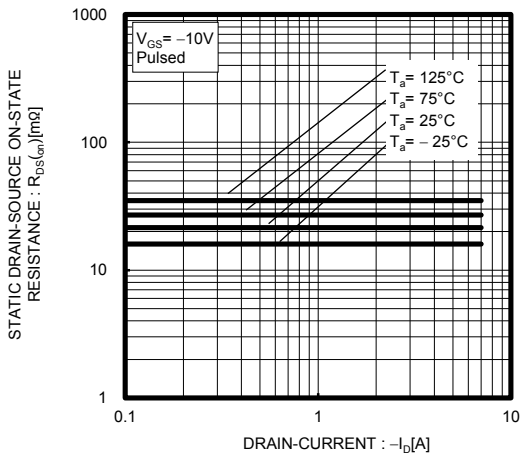


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current ( III )

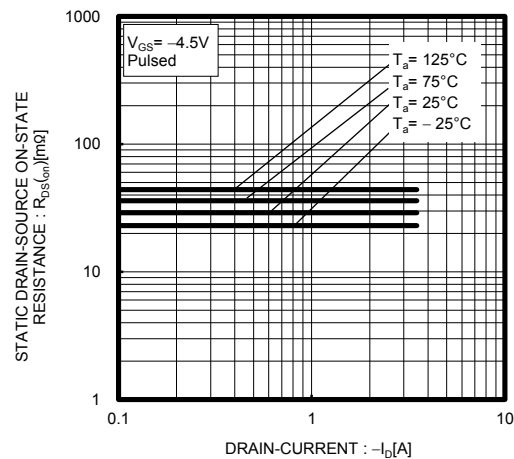


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(IV)

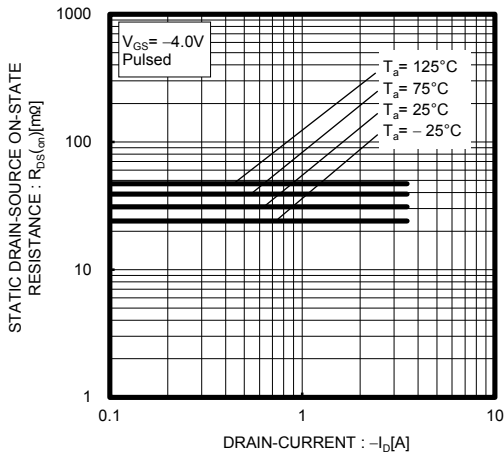


Fig.8 Forward Transfer Admittance vs. Drain Current

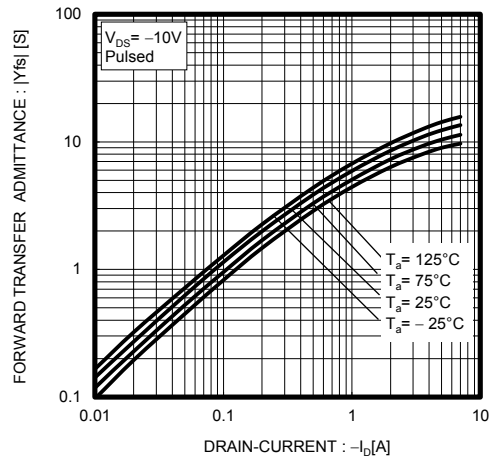


Fig.9 Reverse Drain Current vs. Source-Drain Voltage

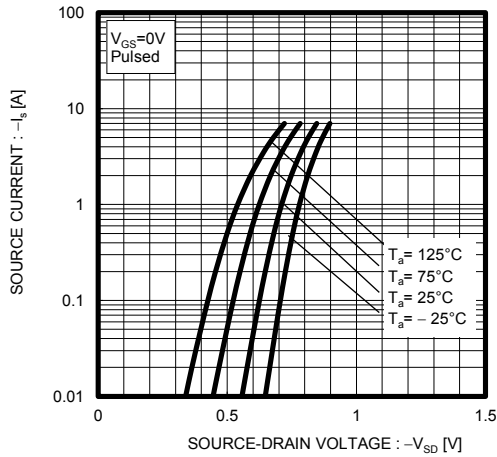


Fig.10 Static Drain-Source On-State Resistance vs. Gate Source Voltage

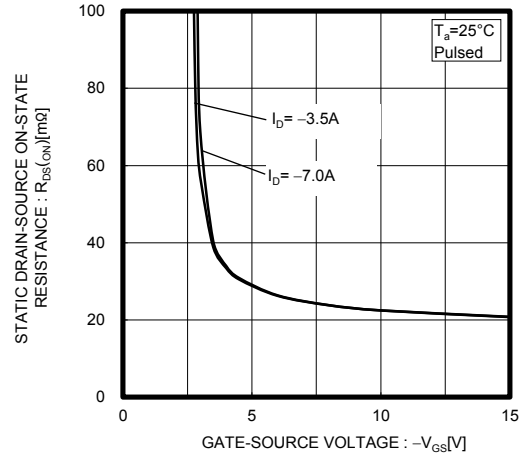


Fig.11 Switching Characteristics

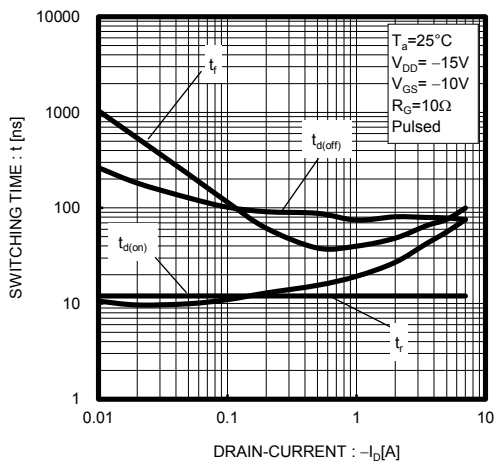


Fig.12 Dynamic Input Characteristics

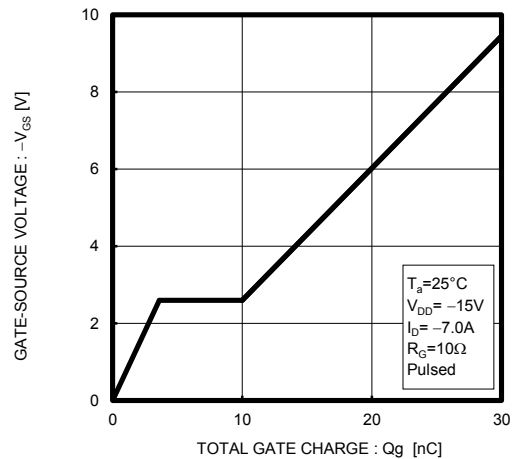




Fig.13 Typical Capacitance vs. Drain-Source Voltage

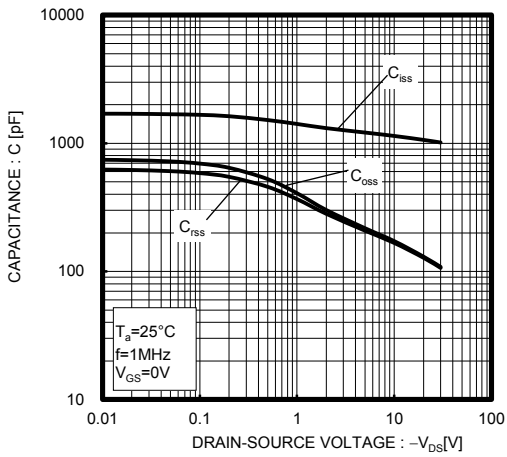


Fig.14 Maximum Safe Operating Area

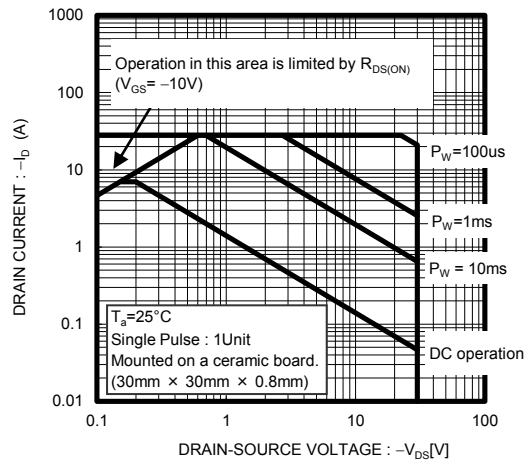
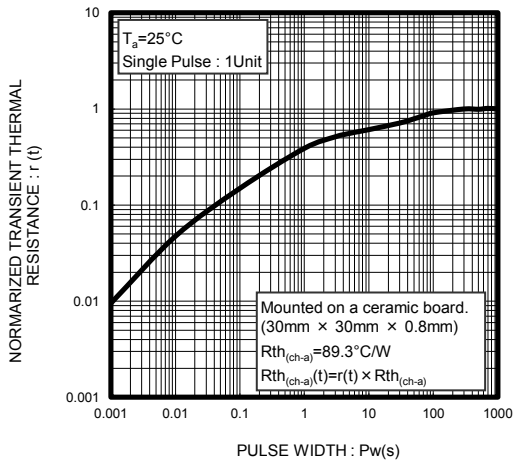


Fig.15 Normalized Transient Thermal Resistance vs. Pulse Width



● Measurement circuits

<Tr1(Nch)>

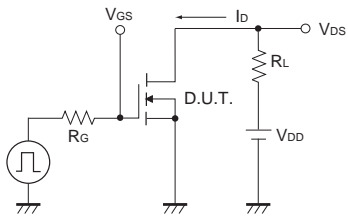


Fig.1-1 Switching Time Measurement Circuit

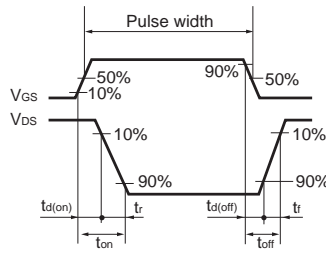


Fig.1-2 Switching Waveforms

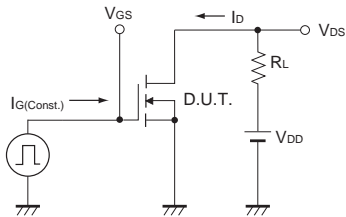


Fig.2-1 Gate Charge Measurement Circuit

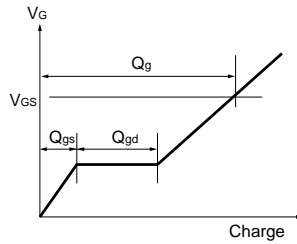


Fig.2-2 Gate Charge Waveform

<Tr2(Pch)>

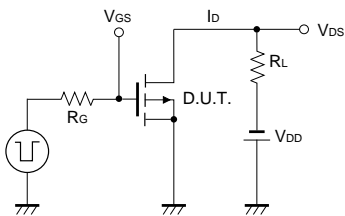


Fig.3-1 Switching Time Measurement Circuit

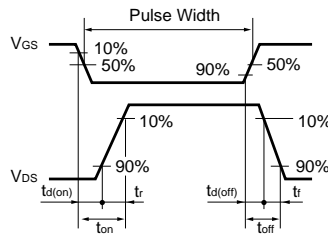


Fig.3-2 Switching Waveforms

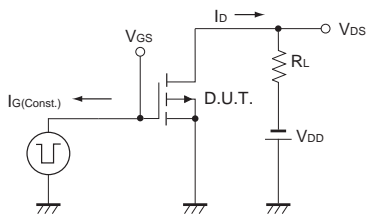


Fig.4-1 Gate Charge Measurement Circuit

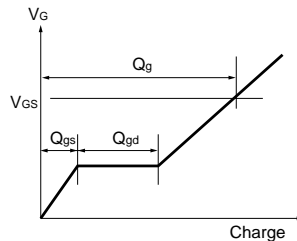


Fig.4-2 Gate Charge Waveform

● Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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